

KEMET Part Number: CDR32BX103BKZS
(C1206N103K1XSL, C1206N103K1XSL-MilitaryBulk)



Ceramic, Military/High Reliability, MilChip-55681, 0.01 uF, 10%, 100 V, 1206, BX, S (0.001%/1000 Hrs)



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General Information

Style:	SMD Chip
Series:	MilChip-55681
Chip Size:	1206
RoHS:	No
Termination:	Lead (SnPb)
Failure Rate:	S (0.001%/1000 Hrs)
Testing and Reliability:	MIL-PRF-55681
Approvals:	MIL-PRF-55681
Miscellaneous:	Termination Description: SolderPlate 70-30

Dimensions

L	3.2mm +/-0.2mm
W	1.6mm +/-0.2mm
T	1.3mm
B	0.5mm +/-0.2mm

Specifications

Capacitance:	0.01 uF
Capacitance Tolerance:	10%
Voltage DC:	100 VDC
Temperature Range:	-55/+125C
Temperature Coefficient:	BX

Packaging Specifications

Packaging:	Bulk, Bag
Packaging Quantity:	1

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